



BCP5616TQ

#### **80V NPN MEDIUM POWER TRANSISTOR IN SOT223**

#### **Description**

This Bipolar Junction Transistor (BJT) is designed to meet the stringent requirements of Automotive Applications.

#### **Features**

- BV<sub>CEO</sub> > 80V
- I<sub>C</sub> = 1A High Continuous Collector Current
- I<sub>CM</sub> = 2A Peak Pulse Current
- 2W Power Dissipation
- Low Saturation Voltage V<sub>CE(SAT)</sub> <500mV @ 0.5A</li>
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen- and Antimony-Free. "Green" Device (Note 3)
- The BCP5616TQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

### **Applications**

- Medium Power Switching or Amplification Applications
- AF Driver and Output Stages

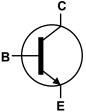
#### **Mechanical Data**

- Case: SOT223
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads.
   Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.112 grams (Approximate)

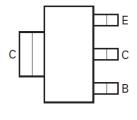




Top View



Device Symbol



Top View Pin-Out

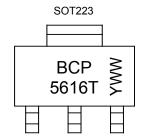
### Ordering Information (Note 4)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
BCP5616TQTA	Automotive	BCP 5616T	7	12	1,000
BCP5616TQTC	Automotive	BCP 5616T	13	12	4,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

## **Marking Information**



BCP 5616T = Product Type Marking Code YWW = Date Code Marking Y or  $\overline{Y}$  = Last Digit of Year (ex: 0 = 2020) WW or  $\overline{W}W$  = Week Code (01~53)



# Absolute Maximum Ratings (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Collector-Base Voltage	V <sub>CBO</sub>	100	V	
Collector-Emitter Voltage	V <sub>CEO</sub>	80	V	
Emitter-Base Voltage	V <sub>EBO</sub>	5	V	
Continuous Collector Current	Ic	1	^	
Peak Pulse Collector Current	I <sub>CM</sub>	2	A	
Continuous Base Current	I <sub>B</sub>	100	mΛ	
Peak Pulse Base Current	I <sub>BM</sub>	200	mA	

### Thermal Characteristics (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Power Dissipation	(Note 5)	$P_{D}$	2.5	W
Thermal Resistance, Junction to Ambient	(Note 5)	$R_{\theta JA}$	45.6	°C /W
Thermal Resistance, Junction to Leads (Note 6)		$R_{ heta JL}$	21.7	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C	

### ESD Ratings (Note 7)

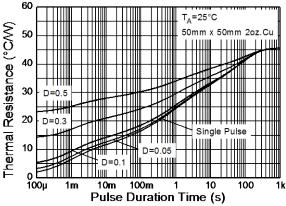
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge – Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge – Machine Model	ESD MM	400	٧	С

<sup>5.</sup> For a device mounted with the collector lead on 50mm x 50mm 2oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady-state.

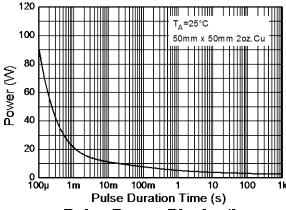
<sup>6.</sup> Thermal resistance from junction to solder-point (at the end of the collector lead).
7. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



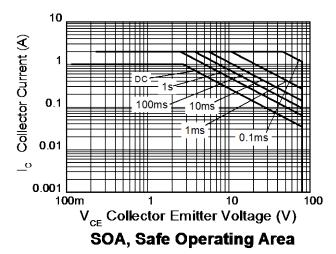
# **Thermal Characteristics and Derating Information**

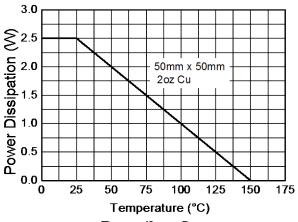


**Transient Thermal Impedance** 



**Pulse Power Dissipation** 





**Derrating Curve** 



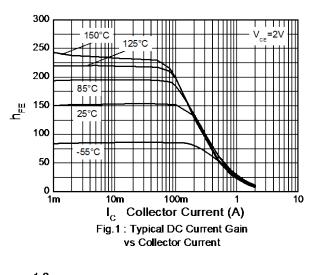
# Electrical Characteristics (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	100	_	_	V	I <sub>C</sub> = 100μA
Collector-Emitter Breakdown Voltage (Note 8)	BV <sub>CEO</sub>	80	_	_	V	I <sub>C</sub> = 10mA
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	7	_	_	V	I <sub>E</sub> = 10μA
Collector Cut-Off Current	I <sub>CBO</sub>	_	_	0.1 20	μΑ	V <sub>CB</sub> = 30V V <sub>CB</sub> = 30V, T <sub>A</sub> = +150°C
Emitter Cut-Off Current	I <sub>EBO</sub>	-	_	20	nA	V <sub>EB</sub> = 6V
Static Forward Current Transfer Ratio (Note 8)	h <sub>FE</sub>	63 100 40	_	250	_	I <sub>C</sub> = 5mA, V <sub>CE</sub> = 2V I <sub>C</sub> = 150mA, V <sub>CE</sub> = 2V I <sub>C</sub> = 500mA, V <sub>CE</sub> = 2V
Collector-Emitter Saturation Voltage (Note 8)	V <sub>CE(sat)</sub>	_	_	0.5	V	I <sub>C</sub> = 500mA, I <sub>B</sub> = 50mA
Base-Emitter Turn-On Voltage (Note 8)	V <sub>BE(on)</sub>	-	_	1.0	V	$I_C = 500 \text{mA}, V_{CE} = 2 \text{V}$
Transition Frequency	f⊤	100	150	_	MHz	I <sub>C</sub> = 50mA, V <sub>CE</sub> = 10V f = 100MHz
Output Capacitance	Сово	_	_	25	pF	V <sub>CB</sub> = 10V, f = 1MHz

Note:

8. Measured under pulsed conditions. Pulse width ≤ 300 µs. Duty cycle ≤ 2%.

# Typical Electrical Characteristics (@ TA = +25°C, unless otherwise specified.)



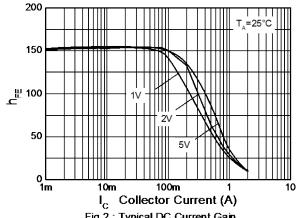
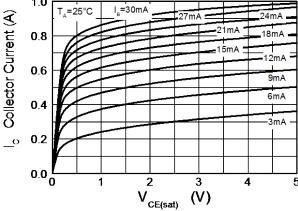


Fig.2: Typical DC Current Gain vs Collector Current



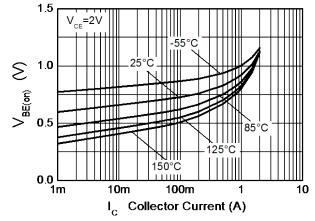


Fig.3: Typical Collector Current vs Collector-Emitter Saturation Voltage

Fig.4: Typical Base-Emitter Turn-On Voltage vs Collector Current



### Typical Electrical Characteristics (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

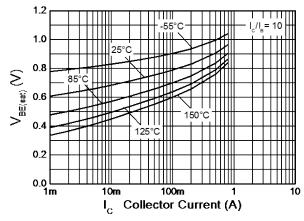


Fig 5: Typical Base-Emitter Saturation Voltage vs Collector Current

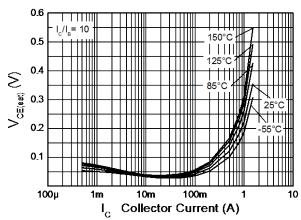


Fig 6: Typical Collector-Emitter Saturation Voltage vs Collector Current

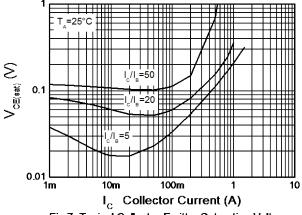


Fig 7: Typical Collector-Emitter Saturation Voltage vs Collector Current

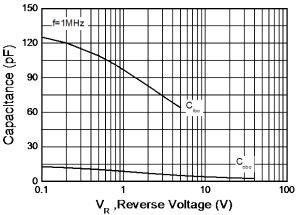
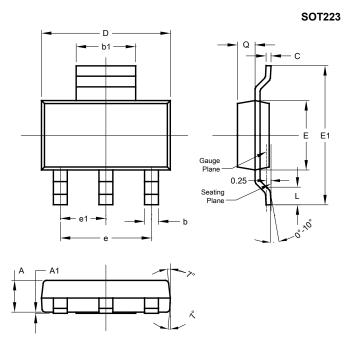


Fig 8: Typical Capacitance Characteristics



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

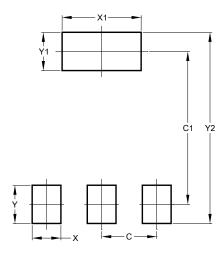


SOT223					
Dim	Min	Max	Тур		
Α	1.55	1.65	1.60		
A1	0.010	0.15	0.05		
b	0.60	0.80	0.70		
b1	2.90	3.10	3.00		
С	0.20	0.30	0.25		
D	6.45	6.55	6.50		
Е	3.45	3.55	3.50		
E1	6.90	7.10	7.00		
е	_	_	4.60		
e1	_	_	2.30		
L	0.85	1.05	0.95		
Q	0.84	0.94	0.89		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### **SOT223**



Dimensions	Value (in mm)
С	2.30
C1	6.40
X	1.20
X1	3.30
Y	1.60
Y1	1.60
Y2	8.00



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